

APPLICATION DATA SHEET

APPLICATION INFORMATION

Application Type::	REGULAR
Subject Matter::	UTILITY
CD-ROM or CD-R?::	NONE
Title::	SEMICONDUCTOR DEVICE INCLUDING COPPER INTERCONNECT LINE AND BONDING PAD, AND METHOD OF MANUFACTURING THE SAME
Attorney Docket Number::	239476US2
Total Drawing Sheets::	12

INVENTOR INFORMATION

Applicant Authority Type::	INVENTOR
Primary Citizenship Country::	Japan
Status::	FULL CAPACITY
Given Name::	Takeru
Family Name::	MATSUOKA
City of Residence::	Tokyo
Country of Residence::	Japan
Street of Mailing Address::	c/o Renesas Technology Corp., 4-1, Marunouchi 2-chome, Chiyoda-ku,
City of Mailing Address::	Tokyo
Country of Mailing Address::	Japan
Applicant Authority Type::	INVENTOR
Primary Citizenship Country::	Japan
Status::	FULL CAPACITY
Given Name::	Noriaki
Family Name::	FUJIKI
City of Residence::	Tokyo
Country of Residence::	Japan
Street of Mailing Address::	c/o Renesas Technology Corp., 4-1, Marunouchi 2-chome, Chiyoda-ku,
City of Mailing Address::	Tokyo
Country of Mailing Address::	Japan

Applicant Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Hiroki
Family Name:: TAKEWAKA
City of Residence:: Tokyo
Country of Residence:: Japan
Street of Mailing Address:: c/o Renesas Technology Corp., 4-1,
Marunouchi 2-chome, Chiyoda-ku,
City of Mailing Address:: Tokyo
Country of Mailing Address:: Japan

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 22850

REPRESENTATIVE INFORMATION

Representative Customer Number:: 22850

FOREIGN PRIORITY INFORMATION

Application Number:	Country::	Filing Date::	Priority Claimed::
2003-002946	Japan	01/09/03	YES

ASSIGNMENT INFORMATION

Assignee Name:: Renesas Technology Corp.
Street of Mailing Address:: 4-1, Marunouchi 2-chome,
Chiyoda-ku,
City of Mailing Address:: Tokyo
Country of Mailing Address:: Japan